

## Declaration For Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought in the invention entitled A METHOD OF WIRE BONDING OF A SEMICONDUCTOR DEVICE FOR RESOLVING OXIDATION OF COPPER BONDING PAD the specification of which

(check one) ☒ is attached hereto.

☐ was filed on \_\_\_\_\_ as

Application Serial No. \_\_\_\_\_

and was amended on \_\_\_\_\_ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

091125383

TAIWAN

23 October 2002

Priority Claimed

☒ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status) (patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status) (patented, pending, abandoned)

And I hereby appoint as principal attorneys

Please direct all communications to the following address:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor

Wen-Lo SHIEH

October 20, 2003

Inventor's signature

Date

Residence

Taiwan

Citizenship

Taiwan

Post Office Address

PO Box 82-144, Taipei, Taiwan

(Supply similar information and signature for second and subsequent joint inventors.)

Full name of second joint inventor, if any HUANG, Fu-Yu  
Second inventor's signature Huang, Fu-Yu October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of third joint inventor, if any HUANG, Ning  
Third inventor's signature Huang Ning October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of fourth joint inventor, if any CHEN, Hui-Pin  
Fourth inventor's signature Chen Hui Pin October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of fifth joint inventor, if any Shu-Wan LU  
Fifth inventor's signature Shu-Wan Lu October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of sixth joint inventor, if any Zhe-Sung WU  
Sixth inventor's signature Zhe-Sung Wu October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of seventh joint inventor, if any Chih-Yu TSAI  
Seventh inventor's signature Chih-Yu TSAI October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of eighth joint inventor, if any CHEN, Mei-Hua  
Eighth inventor's signature Chen Mei-Hua October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of ninth joint inventor, if any LU, Chia-Ling  
Ninth inventor's signature LU, Chia-Ling October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of tenth joint inventor, if any WANG, Yu-Ju  
Tenth inventor's signature Wang, Yu-Ju October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of eleventh joint inventor, if any HUANG, Yu-Chun  
Ninth inventor's signature Huang, Yu-Chun October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of twelfth joint inventor, if any LIU, Tzu-Lin  
Ninth inventor's signature LIU, Tzu-Lin October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of thirteenth joint inventor, if any WENG, Wen-Tsung  
Ninth inventor's signature Weng, Wen-Tsung October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan

Full name of fourteenth joint inventor, if any TSENG, Ya-Hsin  
Ninth inventor's signature Tseng, Ya-Hsin October 20, 2003

Residence Taiwan  
Citizenship Taiwan  
Post Office Address PO Box 82-144, Taipei, Taiwan